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Original published in:	Journal of materials science Dordrecht [u.a.] : Springer Science + Business Media B.V 56 (2021), 20, p. 11866-11880.
Original published:	2021-04-09
ISSN:	1573-4803
DOI:	10.1007/s10853-021-06058-y
[Visited:	2021-09-23]



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Electronic materials



Electrodeposition of cuprous oxide on a porous copper framework for an improved photoelectrochemical performance

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Received: 7 December 2020 Accepted: 29 March 2021 Published online: 9 April 2021

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ABSTRACT

Photoelectrochemical (PEC) water splitting can be an efficient and economically feasible alternative for hydrogen production if easily processed photoelectrodes made of inexpensive and abundant materials are employed. Here, we present the preparation of porous Cu₂O photocathodes with good PEC performance using solely inexpensive electrodeposition methods. Firstly, porous Cu structures with delicate pore networks were deposited on flat Cu substrates employing hydrogen-bubble-assisted Cu deposition. In a second electrodeposition step, the porous Cu structures were mechanically reinforced and subsequently detached from the substrates to obtain free-standing porous frameworks. In a third and final step, photoactive Cu₂O films were electrodeposited. The PEC water splitting performance in 0.5 M Na₂SO₄ (pH \sim 6) shows that these photocathodes have photocurrents of up to -2.25 mA cm^{-2} at 0 V versus RHE while maintaining a low dark current. In contrast, the Cu₂O deposited on a flat Cu sample showed photocurrents only up to -1.25 mA cm⁻². This performance increase results from the significantly higher reactive surface area while maintaining a thin and homogeneous Cu₂O layer with small grain sizes and therefore higher hole concentrations as determined by Mott-Schottky analysis. The free-standing porous Cu₂O samples show a direct optical transmittance of 23% (λ = 400–800 nm) and can therefore be used in tandem structures with a photoanode in full PEC cells.

Handling Editor: Kyle Brinkman.

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GRAPHICAL ABSTRACT



Introduction

Hydrogen is considered as a clean and sustainable energy carrier for the future but is, for economic reasons, currently mainly produced by steam reforming of fossil fuels [1]. A promising method to produce hydrogen from renewable sources is photoelectrochemical (PEC) water splitting [2]. It utilizes direct solar irradiation on photoelectrodes to split water molecules into H_2 and O_2 . These photoelectrodes are usually semiconductors with adequate bandgaps and band positions [3, 4].

To make PEC water splitting a competitive and large-scale industrial process, the development of suitable photoelectrodes with high solar-to-hydrogen efficiencies and low costs is required. The semiconductor cuprous oxide (Cu₂O) has been shown to fulfill these criteria and is considered a promising candidate, which can be easily produced by inexpensive electrochemical [5–7] or thermal annealing [8] methods. Cu₂O is a p-type semiconductor which has suitable band positions for PEC water splitting with the conduction band located 0.7 V more negative than the hydrogen evolution reaction (HER) potential [9] and a direct bandgap of \sim 2.0–2.3 eV, depending on the fabrication process [10–13].

However, the bare Cu₂O has limited chemical stability in the presence of hydrogen evolution (Cu₂O reduces to Cu metal at 0.46 V vs. RHE [14, 15]) and thus is usually coated by thin (< 50 nm) and homogeneous protective layers. Various materials (e.g., TiO₂, ZnO, Al₂O₃, graphite, graphitic carbon nitride, etc.) and methods are available for this purpose and have extensively been researched [16-21]. Additionally, those layers are often modified with electrocatalysts like Pt [14] or Ru [22]. These modifications increase the chemical stability and photocurrent of the Cu₂O electrode, but since so many different materials and processes are used in literature, they make a fair comparison of the underlying Cu₂O performance very difficult. In this paper, we focus only on the bare Cu₂O performance as photocathodes so that we can compare our results better to other publications.

One approach to improve the overall performance for the PEC water splitting of a Cu₂O photoelectrode is by modifying its morphology. An enhancement of the surface area will expose more active sites for the photoelectrochemical reaction and smart nanostructuring can help to overcome one of the Cu₂O intrinsic limitations which is its mismatch between electron diffusion length (typically 20–100 nm) and light absorption depth about 10 μ m [23, 24]. On a flat



electrode, a thin Cu₂O layer would be desired to drive enough electrons to the surface, but a thick layer would be necessary to absorb enough photons. However, by modifying the surface morphology in a way that the thin Cu₂O layer is aligned at a more beneficial angle toward the incoming light or the photon pathway, the absorption inside the Cu₂O layer can be increased significantly while still maintaining a small electron diffusion length to the electrolyte. This can practically be achieved by using vertically aligned Cu₂O nanowires or, as seen in the approach pursued in this work, by Cu₂O coated pore walls. The Cu₂O nanowire structure can be synthesized by either using an anodized aluminum oxide template [25], or thermal annealing [22, 26, 27]. However, these methods can face some other limitations such as inhomogeneous Cu₂O coating on a metal substrate. In turn, the overall PEC water splitting performance can be degraded. In contrast, a Cu₂O film prepared by an electrochemical deposition method, which is an inexpensive and scalable synthesis process, shows more reliable performance and can be implemented on rough or 3D substrates with easily tunable layer thickness by adjusting the deposition parameters such as deposition time and current density or applied potential [28]. A report by Luo et al. [22] shows that Cu₂O nanowires synthesized by using wet chemistry and thermal annealing have poor performance due to the exposed underlying metallic Cu. This was overcome by electrodepositing a thin layer of Cu₂O on the existing Cu₂O nanowire photocathode which improves the PEC water splitting performance significantly.

In recent years, electrochemically deposited 3D porous metal structures have shown promising potential to be utilized as electrode materials with large surface areas and high electronic conductivities for applications in fuel cells [29], batteries [30], electrocatalysts [31], and sensors [32]. The synthesis procedure involves the evolution of hydrogen bubbles, which act as dynamic soft templates during the electrodeposition process and create pores in the deposited metal layer. The pore walls of such metal deposits often grow in ramified dendritic structures [33] which increase the surface area of the deposited layers, but on the other hand, reduce their mechanical stability and adhesion, and thus limit their application as substrate materials.

The combination of ramified porous structures and Cu_2O semiconductors has been reported by Ma et al.

[8]. The ramified porous Cu underwent a thermal annealing process in a low oxygen atmosphere to oxidize the Cu to Cu₂O which was then used for the PEC water splitting. The current density was reported to reach ~ -2.25 mA cm⁻² at 0 V versus RHE. However, a relatively high dark current of ~ -1 mA cm⁻² was observed which according to Ma et al. is possibly due to electrochemical reduction of Cu₂O to Cu, and electrochemical reduction of adsorbed O_2 . Besides this approach, to the best of our knowledge, the electrodeposition of Cu₂O on such porous structures has not been reported. Our approach involves producing highly porous, but mechanically stable Cu structures and coating them with a homogeneous Cu₂O film by using only inexpensive electrodeposition methods.

Experimental details

Electrodeposition of dendritic porous Cu

The porous Cu structures were electrodeposited galvanostatically using a potentiostat (Bio-Logic science instruments SP-240 with a \pm 4 A booster kit) on a flat Cu substrate at current densities between -0.075 A cm⁻² and -2.25 A cm⁻² (Fig. 1). Prior to the electrodeposition procedure, the flat Cu substrate was electropolished in 30 vol. % H₃PO₄ for 1 min at 2 V versus Cu to smoothen the surface (root-meansquare roughness, $R_q = \sim 3 \text{ nm}$, see Fig. S1). The electrodeposition process was done in a three-electrode configuration with the flat Cu as the working electrode, Pt foil as a counter electrode, and Ag/AgCl in saturated KCl as a reference electrode. An aqueous electrolyte consisting of 0.2 M CuSO₄ (Fluka) as Cu source and 1 M H₂SO₄ (Chemsolute) was used. This acidic bath (pH \sim 0) will prevent the formation of oxides on the surface and generate copious amounts of hydrogen for the formation of the porous Cu structure. The flat Cu with an exposed surface area of 1 cm² was placed at the bottom of the cell in a horizontal position which allowed a better release of the hydrogen bubbles during the electrodeposition process. The deposition time was varied between 40 and 400 s depending on the applied current density. During the electrodeposition process, two main cathodic reactions occur in parallel (Eqs. 1 and 2). The hydrogen bubbles disrupt the growth of the Cu layer, creating a porous structure with a dendritic wall.



$$Cu^{2+} + 2e^- \rightarrow Cu$$
 (1)

$$2\mathrm{H}^{+} + 2\mathrm{e}^{-} \rightarrow \mathrm{H}_{2} \tag{2}$$

Reinforcement process of the dendritic porous Cu

A second Cu deposition was carried out, using the same plating bath with a lower current density of -20 mA cm^{-2} to reinforce the dendritic structures. Prior to the reinforcement process, the cell was shaken a few times to release trapped H₂ bubbles from the pores. The electrodeposition time was varied between 5 and 120 min to evaluate the reinforcement of the dendritic porous Cu.

Lift-off process to produce free-standing porous Cu

Some of the reinforced porous Cu samples were placed in an ultrasonic bath (35 kHz/160 W, Bandelin Sonorex Super RK 510 H) for 5 min. In this process, the ultrasonic vibrations destroy the loosely adhering dendrites. The process was repeated at least 3 times to ensure that all the remaining dendrites were removed completely. Since especially the interface region between the flat Cu substrate and the porous Cu could not be reinforced and remained dendritic, it was possible to peel off the porous Cu layer from the substrate, which resulted in a stable free-standing porous Cu framework.

Electrodeposition of a Cu₂O film

In the next step, the free-standing porous Cu samples and the substrate-bound porous Cu samples were coated with a photoactive Cu₂O film by using the potentiostatic electrodeposition method (Fig. 1). Before that, the samples were etched in 0.1 M H_2SO_4 for 20 s to remove native oxide. Then, the samples were placed in an electrolyte consisting of 0.2 M CuSO₄, 1 M Na₃C₆H₅O₇ (trisodium citrate, Sigma-Aldrich) as a complexing agent. The pH of this bath was adjusted to ~ 12 with 6 M NaOH (Carl Roth). The trisodium citrate and the Cu ions will react and form copper(II)-citrate complexes [34, 35] in the electrolyte. This will prevent precipitation of the Cu ions as Cu(OH)₂ in an alkaline solution which is needed to ensure a stable formation of the Cu₂O film [36]. In addition, the use of trisodium citrate will help to prevent further oxidation of the Cu₂O film and improve its overall PEC performance as reported by Cao et al. [37]. The cyclic voltammogram (see Fig. S2) shows a reduction peak of Cu₂O at ~ -0.4 V vs. Ag/ AgCl (sat. KCl). Therefore, the experiment was carried out using the same electrode configuration as for the previous electrodepositions with an applied voltage of -0.4 V vs Ag/AgCl (sat. KCl). The reduction process to Cu₂O under these conditions is shown in Eq. (3) [38]. The electrolyte was kept at 60 °C using a thermostat and magnetically stirred at 400 rpm. The electrodeposition processes were conducted for 5, 20, and 60 min. Cu_2O is stable at room temperature and dry environment. Further oxidation to CuO occurs above 300 °C [39, 40]. All samples were used directly after preparation.

$$2Cu_{(incomplex)}^{2+} + 2OH^{-} + 2e^{-} \rightarrow Cu_2O + H_2O$$
 (3)

Structural and mechanical characterization

The surface morphologies of the porous substrates and the Cu₂O film were investigated using fieldemission scanning electron microscopy (FESEM, Hitachi S-4800). The crystalline structure was characterized by Bragg–Brentano X-ray diffraction (XRD, Siemens/Bruker D5000) using Cu–K α radiation at 40 kV and 40 mA with a 2 θ scan range from 20° to 90° at a scan rate of 0.02° s⁻¹. The thickness of the dendritic porous Cu was investigated using a profilometer (Veeco Dektak 150) with a stylus diameter of 10 μ m, an applied mass of 3 mg, and a



resolution of 0.2 μ m s⁻¹. A leveling procedure was done using the Dektak software to remove the tilt.

An electrode for PEC water splitting must have sufficient mechanical stability to endure mechanical stresses under operation, e.g., caused by hydrogen evolution. To test the mechanical stability of the porous and reinforced Cu samples, a strong hydrogen evolution was conducted at -100 mA for 2 min in 0.5 M Na₂SO₄. The mass loss during this procedure was measured by an analytical balance (Sartorius AG, BP301S).

Photoelectrochemical measurement

The PEC cell consists of a rectangular PMMA container for ~ 40 ml of electrolyte. One side of the container holds and electrically contacts the sample. At the opposing side, a 5 mm thick PMMA window allows for the illumination of the sample with a 150 W simulator (LOT-QuantumDesign solar LS0108/15G) with an AM 1.5 filter. The beam intensity of the solar simulator was adjusted using a reference solar cell so that the light intensity at the position of the sample reached 100 mW cm^{-2} . The current densities were recorded with a Biologic potentiostat SP-240 using linear sweep voltammetry (LSV) in a three-electrode configuration under chopped light illumination (5 s light on and 5 s light off) from the solar simulator. The free-standing porous Cu₂O sample was pinned onto a gold-plated brass coin. This provides good contact and exposes only one side of the porous Cu₂O sample to the electrolyte for a better comparison with the substrate-bound samples. The geometric contact area of the samples with the electrolyte was 1 cm^2 .

The PEC measurements were carried out in an aqueous electrolyte of 0.5 M Na₂SO₄ (Carl Roth) with pH ~6 from -0.1 to -0.7 V vs. Ag/AgCl (sat. KCl) and a scan rate of 5 mV s⁻¹. The cell was purged with argon for 15 min before the PEC measurements. All the potentials for the PEC measurement discussed below were converted from potential vs. Ag/AgCl (sat. KCl) to the reversible hydrogen electrode (RHE) using Eq. (4) where $\mathring{E}_{Ag/AgCl}$ (sat. KCl) is the standard potential of 0.197 V at 25 °C and $E_{Ag/AgCl}$ (sat. KCl) is the measured working potential.

$$E_{RHE} = E_{Ag/AgCl (sat. KCl)} + 0.059pH + E_{Ag/AgCl (sat. KCl)}$$
(4)

This conversion was performed because the potential versus RHE is independent of the pH value and thus simplifies the comparison with other literature data.

Mott-Schottky analysis

At the interface between a semiconductor electrode and an electrolyte, two regions of charge separation are found, the space charge region in the semiconductor and the electrochemical double layer in the electrolyte. The capacitance of the space charge region is usually much smaller than the capacitance of the electrochemical double layer and since they are connected in series, the capacitance of the space charge region determines the overall capacitance. Experimentally this capacitance can be measured by electrochemical impedance spectroscopy (EIS), where a small sinusoidal voltage (15 mV) with varying frequency (between 63 and 30 kHz) is applied to the working electrode. The experimental setup consists of the three-electrode configuration and electrolyte (0.5 M Na₂SO₄) used for the previous PEC measurement including purge with argon gas for 15 min.

To determine the space charge capacitance at different potentials, the potential was scanned from -0.1 to 0.15 V vs. Ag/AgCl (sat. KCl) in steps of 6 mV using the staircase potentio electrochemical impedance spectroscopy (SPEIS) method. By plotting the reciprocal of the square of capacitance (C^{-2}) against the potential, one obtains a Mott-Schottky plot which is generally used to determine characteristic parameters of semiconductors, such as flat-band potential and charge carrier density (acceptors or donors). The semiconductor type can also be determined from the positive (n-type) or negative (p-type) sign of the slope between the charge accumulation plateau and charge depletion plateau seen in the Mott-Schottky plots (Fig. 8). When the applied voltage for a p-type semiconductor is more positive than the flat-band potential, charge accumulation occurs resulting in low C^{-2} values. Vice versa, a more negative potential leads to charge depletion, resulting in high C^{-2} values. The linear part of the curves between the accumulation and depletion plateau was fitted with a linear equation and extrapolated to the intersection with the abscissa. The potential at this value represents the flat-band potential and the slope of the linear equation can be used to estimate the charge carrier density, N_{a} , according to Eq. (5).

$$\frac{1}{C^2} = \frac{-2}{\varepsilon_r \varepsilon_0 A^2 e N_a} \left(E - E_{fb} - \frac{k_B T}{e} \right) \tag{5}$$

In Eq. (5), C is the space charge capacitance, $\varepsilon_{\rm r}$ is the relative dielectric constant of Cu₂O (7.6) [41], $\varepsilon_{\rm o}$ is vacuum permittivity, A is the surface area of the electrode (roughness factor is included), e is the elementary charge, N_a is the acceptor charge carrier density, *E* is the applied potential, E_{fb} is the flat band potential, k_B is Boltzmann constant and *T* is the absolute temperature.

Results and discussion

Dendritic porous Cu template

Important parameters to improve the overall performance of the PEC water splitting are the active area and the surface morphology. Increasing the active area and optimization of the morphology creates more active sites for the photoelectrochemical reactions. By varying the electrodeposition durations (40–400 s) and current densities (-0.075 to -2.25 A cm⁻²), different morphologies (Fig. 2) could be obtained. The walls of the porous structures are made of small ramified structures as was also reported by Shin et al.[33]. All porous Cu layers were deposited with an average thickness of 200–250 µm for better structural comparison (see Fig. S3).

For low current densities and long deposition times, only a small amount of widely scattered porous structures were obtained. At higher current densities, starting from -0.37 A cm⁻² with deposition times of 160 s (Fig. 2c) the substrate gets fully covered with porous structures. The formation of these porous structures is strongly influenced by the amount and size of hydrogen bubbles produced on the surface. The hydrogen bubbles act as insulating objects, blocking the active sites for the growth of Cu [42]. The high current densities trigger higher production of hydrogen and increase the detachment rate of the bubbles from the substrate surface which influences the modification of the pore size diameter. At lower current densities, the Cu deposition has a higher current efficiency (see Fig. S4b), due to a decrease in the hydrogen evolution rate and thus reduces the porosity of the samples (Fig. 1a and b). Bv increasing the current density up to -0.75 A cm⁻², the average pore size on the top layer decreases from $\sim 300 \,\mu\text{m}$ (Fig. 2a–c) to $\sim 100 \,\mu\text{m}$ (Fig. 2d–f). Beyond -0.75 A cm⁻², there is no significant difference in the average pore size, but the number of interconnecting pore tunnels as shown in the insets in Fig. 2d-f increases. It can be observed from the insets of Figs. 2 and Fig. 3a that the walls of the porous structures are made of ramified dendrite structures and contain gaps. The formation of these dendritic structures at the pore walls is triggered by



Figure 2 Scanning electron micrographs of the electrodeposited dendritic porous Cu structures on a flat Cu substrate using different current densities and deposition durations: $\mathbf{a} - 0.075$ A cm⁻²,

400 s; **b** -0.15 A cm⁻², 240 s; **c** -0.37 A cm⁻², 160 s; **d** -0.75 A cm⁻², 100 s; **e** -1.5 A cm⁻², 60 s and **f** -2.25 A cm⁻², 40 s. The insets show magnified images of the pores.





Figure 3 Reinforcement procedure of the dendritic porous Cu (deposited at 1.5 A cm⁻² for 60 s) with **a** no reinforcement **b** 5 min, **c** 30 min, **d** 60 min and **e** 120 min Cu deposition time at

current densities of -20 mA cm^{-2} The two images shown on the right bottom corner are the sample photographs.

surface irregularities such as micro-protrusion which appeared due to preferential deposition of the Cu metal on the active sites. More details on the formation mechanism of these dendritic Cu structures as well as their surface properties have been reported by Wang et al. [43]. Although these dendritic structures increase the surface area tremendously, they are extremely fragile and would be damaged or destroyed in a real PEC water splitting application. Therefore, to investigate the mechanical stability of the dendritic porous Cu during water splitting, the mechanical characterization based on the hydrogen evolution reaction as described in the experimental section was carried out. The mass of the dendritic porous Cu sample (-1.5 A cm^{-2} for 60 s) decreased by $\sim 22\%$ from 21.1 \pm 0.1 mg to 16.3 \pm 0.1 mg. The dendritic structure disintegrated during the process, and small Cu particles could be observed at the bottom of the cell. This shows that the dendritic porous Cu has poor mechanical stability and will have to be reinforced to be used as a substrate material for the PEC water splitting application.

Free-standing porous Cu

To improve the surface morphology and the mechanical stability of the dendritic porous structures, a second Cu deposition process with a small current density of -20 mA cm^{-2} was carried out on

the sample deposited at -1.5 A cm^{-2} for 60 s. This relatively small current density is an important parameter to significantly reduce the hydrogen evolution and enable a homogeneous deposition for a compact Cu layer. Thereby, the gaps in the dendritic morphology of the pore walls (Fig. 3a) are filled with increasing deposition duration as shown in Fig. 3b–e. This transformation, which changes the surface morphology and roughness, also influences the color of the sample as can be seen in the photographs in Fig. 3. Starting from 60 min of the reinforcement process, the structure is more compact and allows its use as a stable substrate for the subsequent Cu₂O deposition (see Fig. S5).

Despite the reinforcement procedure, the bottom part of the reinforced porous Cu is still in its dendritic form (Fig. 4a). Probably the limited transport of the Cu ions through the inner pores near the substrate hinders the deposition process at the bottom region. On the other hand, the weak structural integrity at the bottom region allows the porous Cu layer to be removed easily by ultrasound and form a free-standing framework as shown in Fig. 4b and c. The interconnected pore networks that were observed at the interface between the reinforced porous Cu and the flat Cu substrate, are also absent on the free-standing porous Cu as observed from the top view images in Fig. 4a, and b. It is obvious that the ultrasonic process successfully removed the dendritic



Figure 4 Morphological comparison of **a** substrate-bound and **b** free-standing porous Cu electrodeposited at -1.5 A cm^{-2} for 60 s and reinforced with a second Cu electrodeposition using -20 mA cm^{-2} for 120 min. An ultrasonic bath was used to

layer, which consists mostly of these interconnected pore networks, and thereby created single through pores. As mentioned previously, Cu₂O layers coated on those trough pore walls have a beneficial orientation for light absorption, while keeping the short diffusion length of minority charge carriers to the electrolyte. The improvement in mechanical stability via the reinforcement procedure and subsequent liftoff can be demonstrated by the mechanical characterization, which shows no mass loss for these samples after 2 min of strong hydrogen evolution. The average pore diameter of the free-standing porous Cu was estimated from the SEM images to be in the range of 50–100 µm. During the removal process of the dendrites in the ultrasonic bath and the subsequent lift-off from the substrate, the thickness of the porous Cu layer decreased by $\sim 32\%$ (from $\sim 250 \ \mu m$ for the substrate-bound sample to $\sim 170 \ \mu m$ for the free-standing sample).

While pore walls open the possibility to mitigate the mismatch between adsorption and diffusion length, they also allow part of the light to pass through the photoelectrode. Controlling the pore size by adapting the parameters of the Cu electrodeposition (current density, deposition time) enables the tuning of light transmission through the free-standing porous Cu in such a way that a photoanode

separate the porous layer from the flat Cu substrate and produce a free-standing porous Cu layer (the top image shows the cross-section of the samples and the bottom part shows the top view). c Sample photographs of the free-standing porous Cu.

behind the photocathode could harvest the transmitted light in a full cell configuration or dual photocathode configuration as was reported by Niu et al. [44].

By using ultraviolet–visible (UV–Vis) spectroscopy (Varian Inc., Cary 5000) with a spectral range between 400 and 800 nm, the direct optical transmittance of the sample deposited with an applied current density of -1.5 A cm⁻² for 60 s and reinforced with -20 mA cm⁻² for 120 min was measured to be $\sim 23\%$ (see Fig. S6).

Cu₂O film on different porous substrates

The electrodeposition of the photoactive Cu_2O layer on top of porous and solid Cu substrates was done potentiostatically and the measured currents normalized by the geometric surface area (Fig. 5a). The current densities represent the growth rates of the Cu_2O films, assuming 100% faradaic efficiency. For all samples, the deposition on the pristine Cu surface starts with high values of the absolute current densities that decrease over time, as the surface is getting gradually covered with the less conductive Cu_2O layer. However, the dendritic porous Cu and the reinforced substrate-bound samples show similar behavior of the current densities which become almost constant after 15 s. The dendritic porous Cu in







its non-reinforced state has a very large surface area, which leads to current densities in the range of -14 to -18 mA cm⁻² after 15 s. The reinforced substrate-bound sample, on the other hand, is more compact and has a considerably smaller surface area (Fig. 4) which results in smaller current densities in the range of -6 to -4 mA cm⁻². For both the dendritic porous Cu and the substrate-bound porous Cu, the diffusion of the Cu ions through the small-ramified pores and the complex interconnecting pore networks at the interface might be a limiting factor in the deposition process.

The free-standing porous Cu, which is reinforced and separated from the flat Cu substrate, was exposed to the electrolyte from the front side and the backside. This makes the pore surface more accessible and results in even higher deposition currents than the dendritic porous Cu. The chronoamperometric curve of the Cu₂O deposition on free-standing porous Cu (Fig. 5b) shows that the current densities have similar behavior for all samples which indicates good reproducibility for the preparation of the porous substrates. There is a rapid change in the current densities at the initial stage and then the current decreases at a slower rate over a long deposition time scale which is typical behavior for a potentiostatic process.

The grains of the Cu₂O on the free-standing porous Cu substrate grow larger with increasing deposition time (Fig. 6a–c). For a deposition time of 5 min (Fig. 6a), the SEM micrograph shows a thin layer consisting of grains with sizes between 500 and 800 nm. With increasing deposition time, the grain size increased to about 2–4 μ m. However, no significant change in the grain size of the 20 min sample and the 60 min sample (Fig. 6b–c) could be observed. This trend can be linked to the current transient of the Cu_2O (Fig. 5b), which shows that the deposition current decreases at a much slower rate after 20 min deposition time due to the gradual increase of the amount of the less conductive Cu_2O . This indicates that the deposition time has a strong influence on the layer morphology and the electro-crystallization process.

Due to the complex morphology of the porous structure, it is challenging to measure the thickness of the Cu₂O layer directly. Therefore, an indirect approach to estimate the layer thickness is taken here. Since a potentiostatic electrodeposition method is used, the upper limit of the achievable thickness can be expected from the electrodeposited Cu₂O layer on the flat Cu substrate which was deposited using the same parameters (electrode configuration, potential bias, temperature, and pH) as for the porous Cu substrate with various deposition times. From the cross-sectional SEM images of the Cu₂O layer on flat Cu (see Fig. S7), the thickness varies between \sim 500 nm and \sim 3 µm for the samples with 5 min and 60 min deposition time, respectively.

XRD analysis was used to confirm the identity and the crystal structure of the Cu₂O film. The XRD patterns in Fig. 6d show the comparison of the Cu₂O samples on the free-standing porous Cu with different deposition times. The diffraction peaks matched the XRD pattern of bulk Cu₂O (JCPDS 01-077-0199) with the most intense peaks for the (111) plane, which is a photoactive facet[45], followed by the (200) and (220) planes. The (111), (200), (220), and (311) planes from the porous Cu substrate (JCPDS 01-085-1326) were also present. The sample with 5 min deposition time exhibits five prominent reflections. The peak at 36.4° belongs to the Cu₂O (111) plane and the four Figure 6 Surface morphology comparison of Cu_2O films electrodeposited potentiostatically at -0.4 V vs. Ag/ AgCl (sat. KCl) on the freestanding porous Cu substrate for **a** 5 min, **b** 20 min, and **c** 60 min deposition time in a Cu citrate bath (pH 12) and **d** XRD patterns of those Cu₂O films.



remaining peaks belong to the porous Cu substrate for the (200) and (111) planes. For the 20 min and 60 min samples, there is a significant increase in the intensities of most of the Cu₂O diffraction peaks, especially for the (111) plane while the peak intensity of the porous Cu substrates gradually decreases. The full-width-half-maximum (FWHM) of the Cu₂O (111) plane from the 5 min, 20 min and 60 min samples decrease progressively from 0.44° to 0.41° and finally to 0.35°, respectively. By using the Scherrer equation, crystallite sizes of 22, 24, and 28 nm can be estimated. None of the investigated samples showed reflections belonging to cupric oxide (CuO), confirming the suitability of the electrodeposition method for producing stable Cu₂O layers. The XRD pattern that was obtained using the Bragg-Brentano method is used to provide information regarding the crystal plane that is parallel to a planar surface. The crystal orientation of the Cu₂O influences the crystal facet which is an important factor to improve the performance for the PEC water splitting [45]. In the case of the free-standing porous sample, the Cu₂O was deposited on the top and the inner part of the pore walls. This means that XRD not only probes the parallel crystal planes of the Cu₂O but the perpendicular plane as well (the inner part of the pore wall). As a result, the samples exhibit a powder-like behavior, not because of the intrinsic different crystal plane orientations but due to the special morphology of the porous Cu substrate. As a consequence, it would be rather challenging to determine the texture of the Cu₂O film more quantitatively.

PEC performance of Cu₂O photocathodes

Figure 7 shows the results of LSV measurements with a scan rate of 5 mV s⁻¹ under chopped illumination of Cu₂O films deposited on different substrate types as well as layers obtained at different deposition times on free-standing porous Cu frameworks, respectively.

All samples in Fig. 7a were deposited with Cu₂O films at -0.4 V vs. Ag/AgCl (sat. KCl) in an alkaline bath for 5 min. Under illumination, the Cu₂O deposited on the flat Cu substrate shows a photocurrent of ~ -1.25 mA cm⁻² at 0 V vs. RHE as shown in Fig. 7a. In the dark (light off), the current density of this sample stays constant and close to zero in the potential range between 0.4 and 0 V vs. RHE and then slightly increases to ~ -0.15 mA cm⁻² at -0.15 V vs. RHE. For the dendritic porous Cu₂O sample, the overall current density increases is mostly caused by an undesirably high dark current. In our opinion, there are probably two main reasons why the dark current





Figure 7 Photoelectrochemical analysis of a Cu_2O film deposited for 5 min on different Cu substrates and **b** Cu_2O film deposited on a free-standing porous Cu with different durations using an applied

of the dendritic porous Cu₂O sample is higher than that of the flat Cu_2O sample. (1) The surface area of the dendritic porous sample is much higher than the surface area of the flat Cu₂O sample and therefore the electrochemical reduction process of Cu₂O to Cu is accelerated. (2) The deposition of Cu₂O on the dendritic porous Cu is likely to be inhomogeneous and thin Cu₂O layers are expected in the dendrite structures due to transport limitations of the Cu ions into the small pores. The thickness of the Cu₂O layer seems to be related to its reactivity without illumination. Thicker layers of the semiconductor Cu₂O are less prone to reduction due to their increased electrical resistivity and cause a lower dark current (see also Fig. 5b), while the relatively thin Cu₂O layers in the dendritic structures are more reactive. The two reinforced samples in Fig. 7a (free-standing and substrate-bound) show higher photocurrents than the flat sample, but the substrate-bound Cu₂O sample shows a high dark current while the free-standing Cu₂O sample does not. The cause for this is probably again the inhomogeneously coated dendritic Cu, which is still present for the substrate-bound sample (see Fig. 4a). The free-standing sample on the other hand shows a higher photocurrent density of -2.25 mA cm⁻² at 0 V vs. RHE which is 80% higher than the photocurrent of Cu₂O on flat Cu while still maintaining a very low dark current (see Fig. S8). These promising results, which could not be obtained by the Cu₂O synthesis via thermal oxidation on dendritic porous Cu[8](photocurrent: -2.25 mA cm^{-2} , dark current: -1 mA cm^{-2}), show that the electrodeposition method can stabilize the



potential of -0.4 V vs. Ag/AgCl (sat. KCl). The measurements were done in 0.5 M Na₂SO₄ (pH \sim 6) under chopped illumination.

Cu₂O reduction when deposited on a suitable, high surface area substrate. The stabilization of Cu₂O reduction and decrease of the dark current is likely to be caused by a high-quality homogeneous Cu₂O layer. Furthermore, our results also show a significant improvement compared to the other bare Cu₂O photocathodes (see Table S1) prepared on Cu substrates with nanowire structures (photocurrent: -2.08 mA cm^{-2} , dark current: -0.3 mA cm^{-2} [46] and photocurrent: -0.5 mA cm^{-2} , dark current: close to zero [47]). However, planar Cu₂O films on Au and FTO substrates show a slightly higher photocurrent probably due to the preferred crystal orientation which has been reported to affect the PEC water splitting performance[45]. The deposition time of the Cu₂O film on the free-standing porous Cu also influences the photocurrent density (Fig. 7b), even though it has only a negligible impact on the bandgaps, which are estimated at $\sim 2 \text{ eV}$ (see Fig. S9). The short deposition time of 5 min leads to the highest photocurrents, while longer deposition times decrease the photocurrent. To evaluate the influence of Cu₂O deposition time on the chemical stability of the free-standing porous Cu₂O samples, the LSV measurements were repeated three times (see Fig. S10). The photocurrent of the 5 min deposited sample degrades at a much faster rate from -2.25 to -1 mA cm^{-2} at 0 V vs. RHE between the first two sweeps whereas the photocurrent of the 20- and 60-min deposited samples reduces at a much slower rate. This indicates that the PEC degradation is strongly influenced by the layer thickness which demonstrates that the thicker bare Cu₂O layer has slower photodegradation than the thin and more catalytic Cu_2O film. Further investigation of the freestanding porous Cu_2O for the long-time stability measurement and PEC water splitting efficiency will not be discussed here because it can only be determined after a protective coating is applied to the layer.

Mott-Schottky plots (Fig. 8a-c) were performed at frequencies of 30, 40, 50, and 63 kHz to determine the flat-band potential and charge carrier density of the Cu₂O layers deposited on the free-standing porous Cu samples at various deposition times (5, 20, and 60 min). The data confirm that the Cu₂O semiconductor is of p-type, due to the negative slope between the high plateau and low plateau observed in these graphs. The flat-band potential lies between 0.63 and 0.66 V vs. RHE (Fig. 8d) which is in agreement with the values reported in the literature $(\sim 0.65 \text{ V vs. RHE})$ [22] and placed the conduction band position to be more negative than the HER potential. The chronoamperometric curve in Fig. 5b shows reproducible currents for the Cu₂O deposition. This suggests that the surface areas of the underlying free-standing porous Cu frameworks are very similar. The reproducibility of the morphology and the

pore sizes of the samples is also supported by the SEM images in Fig. S11. Since the surface area of the free-standing porous Cu does not vary significantly between samples and the thin Cu₂O layer does not have a significant influence, most of the surface area change is probably due to the roughness variation due to the different crystallinity of the Cu₂O film deposited at different durations. The surface roughness of the samples was investigated by AFM (see Fig. S12) using the Nanoscope Analysis software from Bruker. The roughness factor was then extracted from the local surface area increase which was estimated to be 1.17, 1.36, and 1.41 for the samples deposited for 5 min, 20 min, and 60 min, respectively. The charge carrier densities were then calculated by considering the roughness factor to the surface area in Eq. (5) which provides the value $\sim 4.9 \times 10^{18} \text{ cm}^{-3}$ between $\sim 2.5 \times 10^{17}$ and (Fig. 8e). While the variation in the flat-band potential is minor among the three samples over the investigated range of frequencies, the charge carrier density varies more strongly. Especially for the deposition time of 5 min, an increase in the hole of $\sim 4.9 \times 10^{18} \text{ cm}^{-3}$ could concentration be observed. This high value might be caused by the



Figure 8 Mott-Schottky plots of deposited Cu₂O films on freestanding porous Cu for **a** 5 min, **b** 20 min and **c** 60 min deposition time at various frequencies in 0.5 M Na₂SO₄ (pH \sim 6). The flat-

band potential E_{fb} and the charge carrier density N_a were plotted against the frequency in (d) and (e), respectively.



smaller grain size of the Cu₂O crystals as well as the thinner layer thickness which can influence the conductivity of the film and thus contribute to the improvement of the overall PEC water splitting performance as was shown in Fig. 7b. The influence of the various frequencies on the charge carrier density is relatively small which suggests that the chosen frequency range is suitable for a reliable determination of the doping level of this system.

Conclusions

A preparation route has been suggested to produce efficient Cu₂O photoelectrodes using only electrodeprocesses. Hydrogen-evolution-assisted position copper electrodeposition was used to create a dendritic porous Cu structure with a high surface area. Higher current densities produced a better distribution of the pores, increased interconnecting pore networks, and reduced the average pore size from \sim 300 µm to \sim 100 µm. A second electrodeposition procedure was carried out at a lower current density (-20 mA cm^{-2}) to mechanically reinforce the dendritic porous Cu structures. Subsequently, an ultrasonication process separates the reinforced porous layer from the flat Cu substrate to form a stable freestanding porous Cu framework, which has tubular shaped through pores.

A layer of Cu₂O was electrodeposited in an alkaline copper bath on various porous and flat Cu substrates. The PEC water splitting results revealed that the Cu₂O film deposited on a flat Cu substrate showed a photocurrent density of ~ -1.25 mA cm⁻² at 0 V vs. RHE under 1.5 AM illumination. The best overall results were obtained for the free-standing porous Cu₂O sample, combining a high overall current density (~ -2.25 mA cm² at 0 V vs. RHE), which is 80% higher than the Cu₂O on flat Cu substrate, with a low dark current. The special geometry of the free-standing Cu framework allows for Cu₂O coated tubular pore walls, which are preferentially oriented toward the irradiating light, and can help to mitigate the inherent mismatch between photon absorption length and electron diffusion length in Cu₂O. In comparison to other works based on bare Cu₂O photocathodes on Cu substrates, our samples show excellent improvement on the photocurrent as well as the dark current. Thin and homogeneous Cu₂O layers obtained from the short deposition time

(5 min) lead to the highest photocurrents, which is in agreement with the higher doping level that was observed by Mott-Schottky analysis. The UV–Vis transmission spectroscopy measurement also reveals that the free-standing porous Cu_2O has a transmittance of 23% which makes these structures promising candidates to be used in a tandem system with a photoanode in full PEC cells.

Acknowledgements

Mario Kurniawan is grateful for the financial support provided by the "Thüringer Graduiertenförderung" and the "TU Ilmenau Stipendium".

Funding

Open Access funding enabled and organized by Projekt DEAL.

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Supplementary Information: The online version contains supplementary material available at http s://doi.org/10.1007/s10853-021-06058-y.

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